

Muzaffer Nizam

Sr. Hardware Design Engineer

Location : Antalya, TURKEY
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TOTAL EXPERIENCE (7 Years 4 Months)

Personal Statement

Before I started to Engineering Study, I quit my Mathematics education. I realized that if I am an engineer I can solve more mathematics problems. So it happened too. I love creating a solution for any problem not only working life but also all real life.

I have always wondered new things and explored to create a solution to new challenges. I am married not only to my wife but also to my job. For instance i have always helped her make the right decisions when a colleague was about to make the wrong decision at work. I've never been perfect, but I've always tried to do great things. I have always pursued real truths, not my own truths. I have always tried to apply the real truths. In the future, I will always continue to pursue the real truth in my works.

I have never been egotistical. I've always been tolerant. Maybe good things can be done alone, but more great things can be achieved with teamwork.

I am ready to new role and new life. So are your company ready to run with me?

Education

Bachelor's of Science, Electrical & Electronics Engineering
Akdeniz University

Oct. 2016

What do I do while I am designing Hardware;

- I am using Altium and Kicad EDA programs in Hardware Designs. If it is small project and which contains low speed signals I prefer Kicad, if it is big project and which contains high speed signals I prefer Altium Designer.
- Pin assignment with STM32CubeIDE or CubeMX according to role such as communicating, input, output, PWM, Analog etc for to prepare Low level driver and to design schematic (if I use STM32 MCU family)
- Design Compliant with IPC2221 Electrical Conductor Spacing Standards and EMC Standards,
- Design Compliant with different density Via dimensions of IPC-2221,
- Design Compliant with different Environmental Temperatures and Pressures Track width
- Multi layer PCB Designs 2,4 and more Layers,
- Flex and Poly-amide PCB Design,
- Design compliant with BGA components
- Choosing different temperatures density PCB Materials such as FR-4 TG 130-140, TG 170 etc,
- Various Analog and Digital Circuit Design with 32 bits ARM Core and 8 bits STM 8 Core MCUs such as STM32xx, CC13xx Ti, TM4Cxx Tiva Series MCUS, NXP MCUs etc.
- Power Circuit Designs Such as Switching Regulators or Switching Controllers
- Motor Control Drivers Designs such as Brushed DC, BLDC, PMSM etc
- Digital Designs SPI, I2C, DAC, RS485, UART, Ethernet, CAN Bus isolated or non isolated.
- Wireless Communication Designs GSM, GNSS, Bluetooth, RF Sub 1 Ghz, Wifi,
- System Modelling, simulating and analyzing with Matlab Simulink,
- Analog Designs ADC, DAC, FSK Communication on Power Line, various OP-AMPS Gain Calculating, Analog Filters Designs,
- Simulate with LTSpices, Measurements with Oscilloscopes adding to Reports documents
- Environmental Test such as Temperature test, Pressure Test, ESD Gun Test,
- Creating PBA and PCB Production Files such as Gerber Files, Pick and Places Files, DXF and Step files for Mechanical Designs,
- Layer Stack Management,
- Controlling with GERBV (free Gerber viewer),
- Prepare Bill of Materials List,
- Version Control with github,
- Short Circuit Testing,
- Voltage Level Testing,

What do I do while I am designing Firmware ;

- Code Generation with STM32CubeIDE,
- Low level driver preparing such as below,
- UART/USART Communication Firmware Testing,
- Can Bus Communication Firmware Testing,
- SPI, I2C and RS485 Communication Firmware Testing,
- ADC Input Firmware Testing,
- DAC Output Firmware Testing,
- PWM Generation Firmware Testing,
- General Input detect and Output Control Check Firmware Testing even including Interrupts,
- Hardware Verification with Firmware.

Interested In Below;

- VHDL Design,
- Motor Control Applications with FOC algorithms,
- PID algorithms,

JOB EXPERIENCES

1- Electrical & Electronics Engineer Intern (3 Months)

June 2013- September 2013

Company: Turkcell Communication A.Ş.

Website: <https://www.turkcell.com.tr/>

Job Type: Intern / Full Time

Reason for Leaving: Intern Finished

Job Deification:

- GSM Base Station Location Planning,

- Various Technical Calculating,
- Field operations.

2- Electronics R&D Engineer (2 Years 4 Months)

August 2015- October 2017

Company: Desird Tasarım Arge Uygulama Elekt. Des. İth. İhr. San LTD ŞTİ

Website: <https://desird.com/>

Job Type: Permanent/Full Time

Reason for Leaving: Military Status

Job Deification:

Hardware Designed below projects;

- Biomedical Electronic Card Designs
- Elevator DC Door Control Driver Board Designs
- IOT Card Designs
- Telemetry Card Designs communication with FSK on DC Power Line
- Main Board Designed which is communicating with Telemetry Cards,
- Test Machine Design contains with Pogo Test Probe Tips
- In addition in relevant projects doing Hardware Designs(Schematic and PCB), Measuring, Reports and Tests,
- Designed with STM32xx, CC13xx Ti MCU's, PIC18xx MCU's

3- Electronics R&D Engineer (2 Years 10 Months)

May 2018- February 2021

Company: Desird Tasarım Arge A.Ş. (Same Company previous one, but Commercial Title of Company changed)

Website: <https://desird.com/>

Job Type: Permanent/Full Time

Reason for Leaving: Resignation

Job Definition:

Hardware Designed below projects;

- Elevator BLDC Door Control Driver Board Designs
- IOT Card Designs
- Test Equipment Design contains with Pogo Test Probe Tips
- Railway BLDC Door Control and Safety Boards which has Safety Relay and compatible relevant SIL Certificate,
- In addition in relevant projects doing Hardware Designs(Schematic and PCB), Measuring, Reports and Tests,
- Designed with STM32xx, STM8xx, NXP MCU's, PIC16xx MCU's

4- Electronics R&D Engineer (1 Years 2 Months)

February 2021- April 2022

Company: Ake Elevator and Escalator LTD

Website: <https://ake.com.tr/>

Job Type: Permanent/Full Time

Reason for Leaving: Company created another Company as for Electronics R&D called Aciri Industrial LTD ŞTİ

Job Definition:

Hardware Designed below projects;

- Elevator DC Door Control Driver Board Designs
- Remote control with GSM Communication Card Designs
- Various Elevator Control Boards Designs,
- Water Vending Control Boards Designs,
- Elevator Main Control, Cabin Buttons Boards, Top and Bottom of Cabinet Boards, Floor Calling Boards which is communicating with CAN Bus and DC and AC signal Lines,
- In addition in relevant projects doing Hardware Designs(Schematic and PCB), Measuring, Reports and Tests,
- Designed with TM4Cxx Ti, MSP432xx ARM Core, MSP430xx Ti

5- Electronics R&D Engineer (9 Months)

April 2022 - Still Working

Company: Acri Industrial LTD ŞTİ

Website: <https://www.acritechnology.com/>

Job Type: Permanent/Full Time

Reason for Leaving: Low Salary and Economic Problems in Turkey, Turkish Lira currency lose, Inflation on Turkey.

Job Definition:

Hardware Designed below projects;

- Elevator DC Door Control Driver Board Designs
- Remote control with GSM Communication Card Designs
- Various Elevator Control Boards Designs,
- Elevator Main Control, Cabin Buttons Boards, Top and Bottom of Cabinet Boards, Floor Calling Boards which is communicating with CAN Bus and DC and AC signal Lines,
- Test Machine Design contains with Pogo Test Probe Tips
- In addition in relevant projects doing Hardware Designs(Schematic and PCB), Measuring, Reports and Tests,
- Designed with TM4Cxx Ti, STM32xx,

Personal Design Project and designed by me;

- It is called STM32 Mega Development Board
- Contains Technologies as a below;
 - ✓ 24V AC or DC Power Input,
 - ✓ 2 different Switching Regulator GSM and General System Power as 4.3V and 5V,
 - ✓ Controlling GSM Power with XOR Gate and Transistor,
 - ✓ Analog Bus Voltage Read with Buffer op amp,
 - ✓ DAC Output,
 - ✓ Voltage levels are 24V, 15V, 5V, 4.3V, 3.3V,
 - ✓ USART communication with USB Mini also contains Programming,
 - ✓ CAN Bus Communication,
 - ✓ RS485 Communication,
 - ✓ SPI and I2 Communication connected to Connectors,
 - ✓ SD Memory Card communicated with SPI Interface,
 - ✓ 16x2 Character LCD Display communicated with I2C Interface,
 - ✓ FLASH Memory communicated with I2C Interface
 - ✓ Non-Isolated Signal Input,
 - ✓ Darlington Output with ULN2004 IC,
 - ✓ Linear Potentiometer Analog Read,
 - ✓ Between Range of 0V to 600V DC Voltage Read with op amp,
 - ✓ Between Range of 0-10A Current Read with op amp,
 - ✓ Short Circuit Detection,
 - ✓ DC and BLDC Motor Control Driver Circuit with Back EMF Current Reading,
 - ✓ Encoder Input (Absolute and Incremental)
 - ✓ 16 Channel Isolated Input detected with Shift Register Input,
 - ✓ Accelerometer (ADXL345 IC) communicated with SPI,
 - ✓ 4 Buttons for LCD Controlling,
 - ✓ 24V Relay Output (SPDT 1 FORM C),
 - ✓ SIM800C GSM Modul communicated with SPI Interface

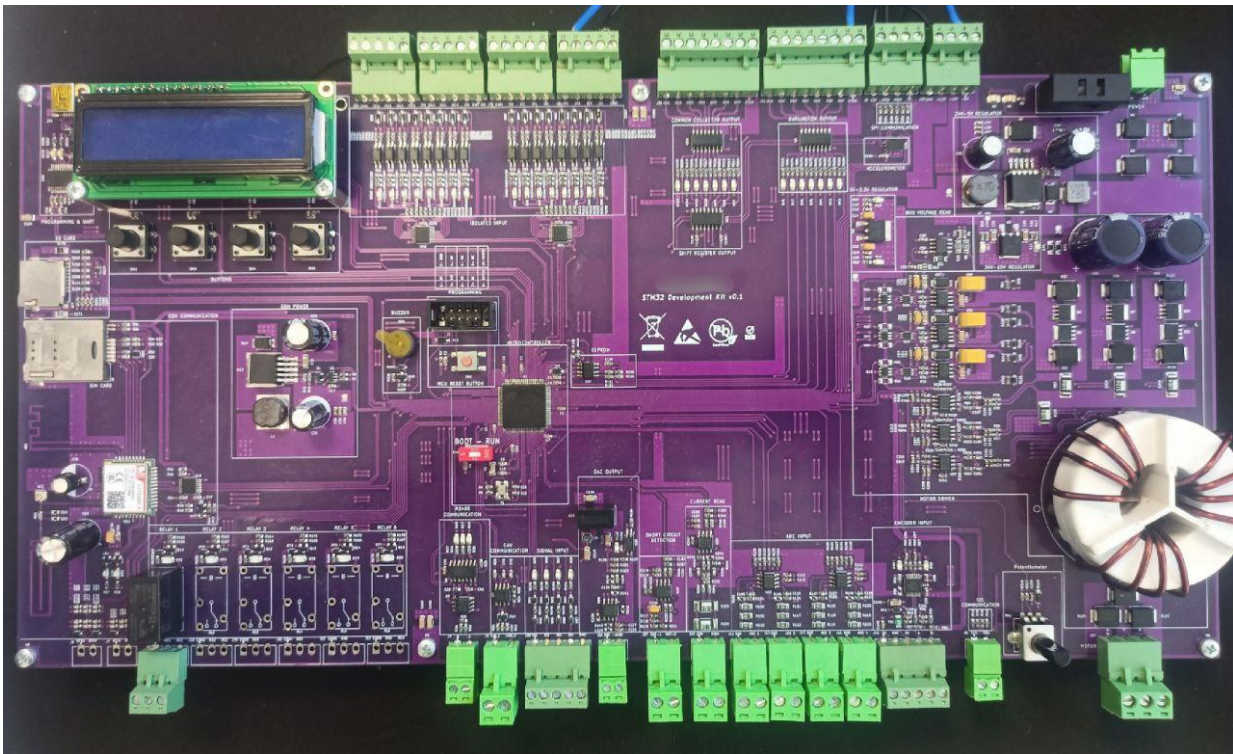


Figure 1 : STM32 MEGA Development Board

Foreign Language

- ✓ English Level : B2-Upper Intermediate (Preparing School of University & English Culture Course in Antalya)

Certificates

- ✓ Safety Integrity Level for RAILWAY SYSTEM ELECTRONICS - **TUV NORD**
- ✓ Humanoid Robots Industrial Automation - **ENTEK EDUCATION TECH.**

April 2019
December 2012

Hobbies

- Latin Dances Salsa & Bachata
- Taking Photo
- Cats and Dogs
- Flying a Kite